

Product Overview

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PRODUCT OVERVIEW

OVERVIEW

The S3C7574 single-chip CMOS microcontroller has been designed for high performance using Samsung's newest 4-bit CPU core, SAM47 (Samsung Arrangeable Microcontrollers).

With features such as, DTMF Generator, LCD direct drive capability, 8-bit timer/counter, and watch timer, the S3C7574 offers an excellent design solution for a wide variety of telecommunication applications that require LCD functions.

Up to 15 pins of the 64-pin QFP package, it can be dedicated to I/O. Four vectored interrupts provide fast response to internal and external events. In addition, the S3C7574's advanced CMOS technology provides for low power consumption and a wide operating voltage range.

OTP

The S3C7574 microcontroller is also available in OTP (One Time Programmable) version, S3P7574. The S3P7574 microcontroller has an on-chip 4-Kbyte one-time-programmable EPROM instead of masked ROM. The S3P7574 is comparable to S3C7574, both in function and in pin configuration.

FEATURES

Memory

- 256 × 4-bit data RAM
- 32 × 4-bit display RAM
- 4096 × 8-bit ROM

I/O Pins

- Input only: 4 pins
- I/O: 11 pins
- Output: 8 pins sharing with segment driver outputs

LCD Controller/Driver

- Maximum 16-digit LCD direct drive capability
- 32 segment, 4 common pins
- Display modes: Static, 1/2 duty (1/2 bias)
1/3 duty (1/2 or 1/3 bias), 1/4 duty (1/3 bias)

8-Bit Basic Timer

- Programmable interval timer
- Watchdog timer

8-Bit Timer/Counter

- Programmable 8-bit timer
- External event counter
- Arbitrary clock frequency output

Watch Timer

- Real-time and interval time measurement
- Four frequency outputs to BUZ pin
- Clock source generation for LCD

Bit Sequential Carrier

- Support 16-bit serial data transfer in arbitrary format

DTMF Generator

- 16 Dual-tone frequencies for tone dialing applications (only 3.58 MHz)

Interrupts

- Two internal vectored interrupts
- Two external vectored interrupts
- Two quasi-interrupts

Memory-Mapped I/O Structure

- Data memory bank 15

Two Power-Down Modes

- Idle mode (only CPU clock stops)
- Stop mode (main or sub system oscillation stops)

Oscillation Sources

- Crystal, ceramic, or RC for main system clock
- Crystal or external oscillator for subsystem clock
- Main system clock frequency: 4.19 MHz (typical)
- Subsystem clock frequency: 32.768 kHz
- CPU clock divider circuit (by 4, 8, or 64)

Instruction Execution Times

- 0.95, 1.91, 15.3 μ s at 4.19 MHz (main)
- 122 μ s at 32.768 kHz (subsystem)

Operating Temperature

- -40 °C to 85 °C

Operating Voltage Range

- 2.0 V to 5.5 V at 4.19 MHz
- 1.8 V to 5.5 V at 3 MHz

Package Type

- 64-QFP-1420F
- 64-QFP-1414

BLOCK DIAGRAM

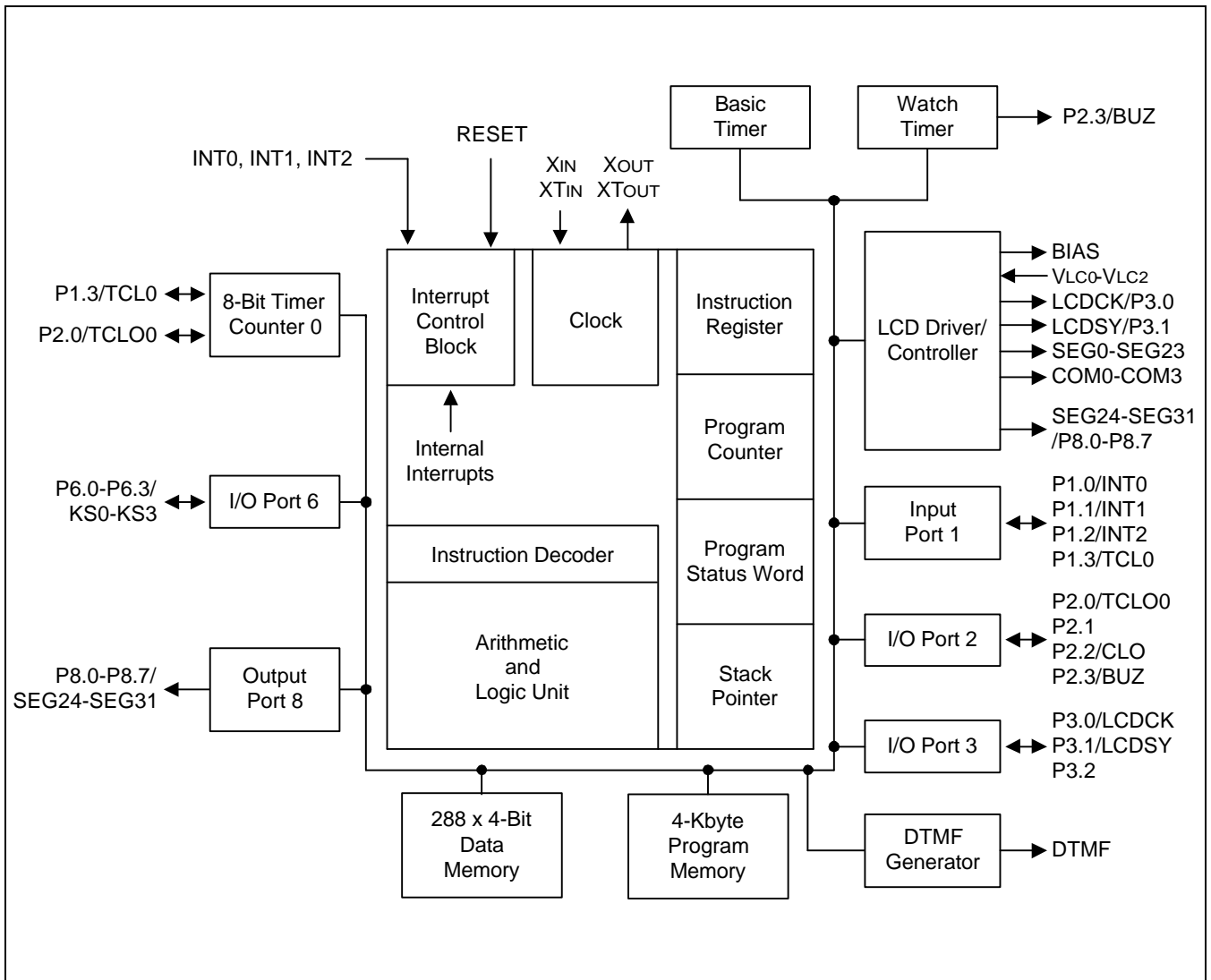


Figure 1-1. S3C7574 Simplified Block Diagram

PIN ASSIGNMENTS

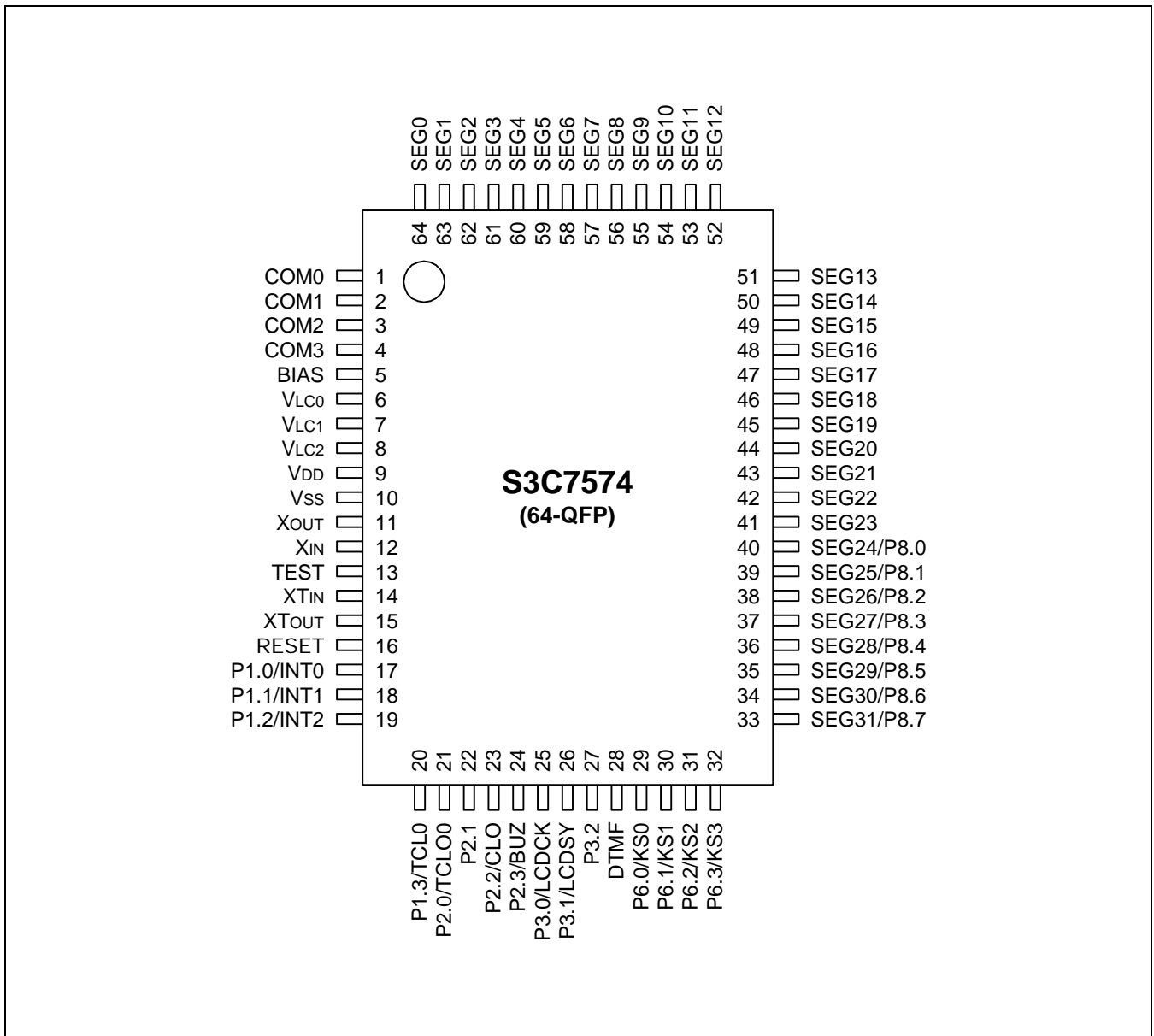


Figure 1-2. S3C7574 64-QFP Pin Assignment

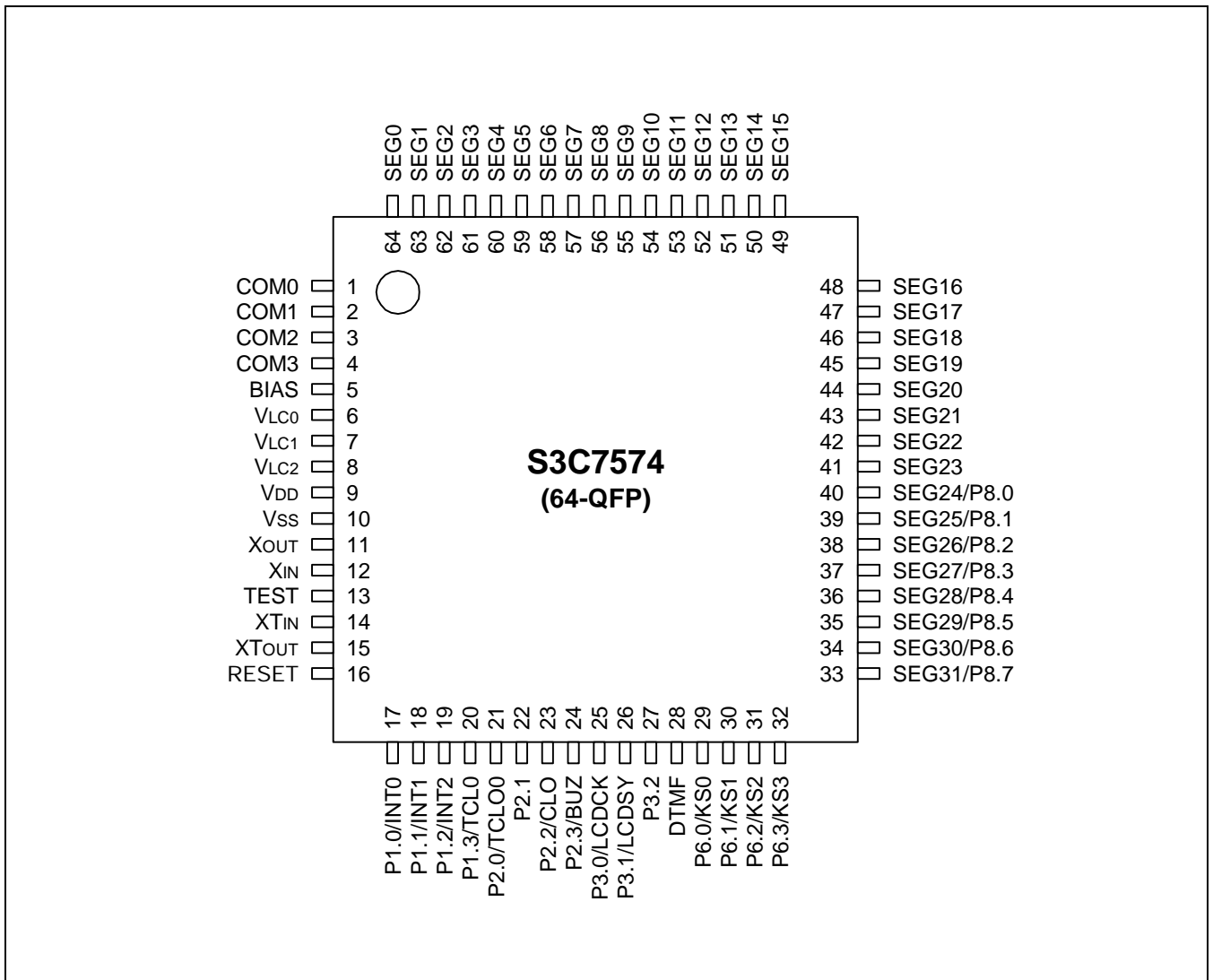


Figure 1-3. S3C7574 64-QFP Pin Assignment

PIN DESCRIPTIONS

Table 1-1. S3C7574 Pin Descriptions

Pin Name	Pin Type	Description	Number	Share Pin	Reset Value	Circuit Type
P1.0 P1.1 P1.2 P1.3	I	4-bit input port. 1-bit or 4-bit read and test is possible. 4-bit pull-up resistors are software assignable.	17 18 19 20	INT0 INT1 INT2 TCL0	Input	A-4
P2.0 P2.1 P2.2 P2.3	I/O	4-bit I/O port. 1-bit and 4-bit read/write and test is possible. 4-bit pull-up resistors are software assignable.	21 22 23 24	TCLO0 – CLO BUZ	Input	D
P3.0 P3.1 P3.2	I/O	4-bit I/O port. 1-bit and 4-bit read/write and test is possible. Each individual pin can be specified as input or output. 4-bit pull-up resistors are software assignable.	25 26 27	LCDCK LCDSY –	Input	D
P6.0–P6.3	I/O	4-bit I/O ports. Pins are individually software configurable as input or output. 1-bit and 4-bit read/write and test is possible. 4-bit pull-up resistors are software assignable.	29–32	KS0–KS3	Input	D
P8.0–P8.7	O	Output port for 1-bit data (for use as CMOS driver only)	33–40	SEG24–SEG31	Output	H-1
DTMF	O	DTMF output	28		Output	G-6
SEG0–SEG23	O	LCD segment signal output	41–64	–	Output	H
SEG24–SEG31	O	LCD segment signal output	33–40	P8.0–P8.7	Output	H-1
COM0–COM3	O	LCD common signal output	1–4	–	Output	H
V _{LC0} –V _{LC2}	–	LCD power supply. Built-in voltage dividing resistors	6–8	–	–	–
BIAS	–	LCD power control	5	–	–	–
LCDCK	I/O	LCD clock output for display expansion	25	P3.0	Input	D

Table 1-1. S3P7574 Pin Descriptions (Continued)

Pin Name	Pin Type	Description	Number	Share Pin	Reset Value	Circuit Type
LCDSY	I/O	LCD synchronization clock output for LCD display expansion	26	P3.1	Input	D
TCL0	I	External clock input for timer/counter 0	20	P1.3	Input	A-4
TCLO0	I/O	Timer/counter 0 clock output	21	P2.0	Input	D
INT0 INT1	I	External interrupt. The triggering edge for INT0 and INT1 is selectable. Only INT0 is synchronized with the system clock.	17 18	P1.0 P1.1	Input	A-4
INT2	I	Quasi-interrupt with detection of rising edge signals.	19	P1.2	Input	A-4
KS0–KS3	I/O	Quasi-interrupt input with falling edge detection.	29–32	P6.0–P6.3	Input	D
CLO	I/O	CPU clock output	23	P2.2	Input	D
BUZ	I/O	2, 4, 8 or 16 kHz frequency output for buzzer sound with 4.19 MHz main system clock or 32.768 kHz subsystem clock.	24	P2.3	Input	D
X _{IN} , X _{OUT}	–	Crystal, ceramic or RC oscillator pins for main system clock. (For external clock input, use X _{IN} and input X _{IN} 's reverse phase to X _{OUT})	11, 12	–	–	–
XT _{IN} , XT _{OUT}	–	Crystal oscillator pins for subsystem clock. (For external clock input, use XT _{IN} and input XT _{IN} 's reverse phase to XT _{OUT})	14, 15	–	–	–
V _{DD}	–	Main power supply	9	–	–	–
V _{SS}	–	Ground	10	–	–	–
RESET	–	Reset signal	16	–	Input	B
TEST	–	Test signal input (must be connected to V _{SS})	13	–	–	–

NOTE: Pull-up resistors for all I/O ports automatically disabled if they are configured to output mode.

PIN CIRCUIT

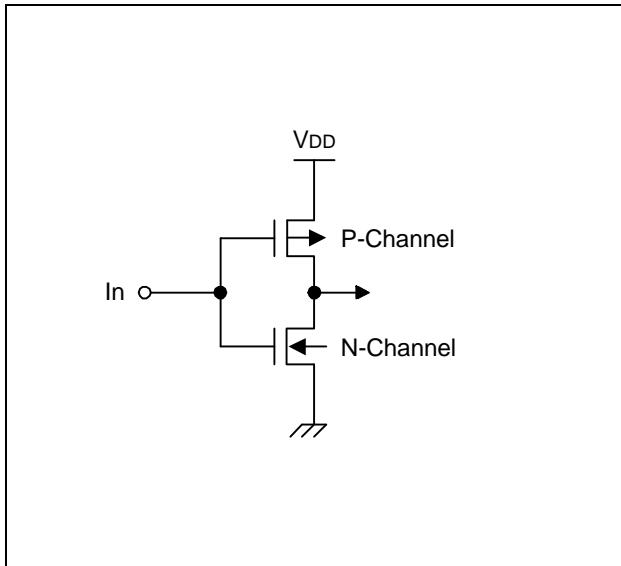


Figure 1-4. Pin Circuit Type A

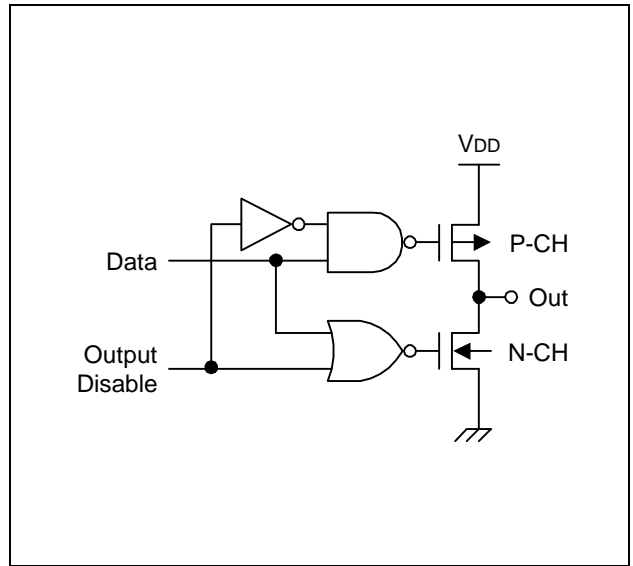


Figure 1-6. Pin Circuit Type C

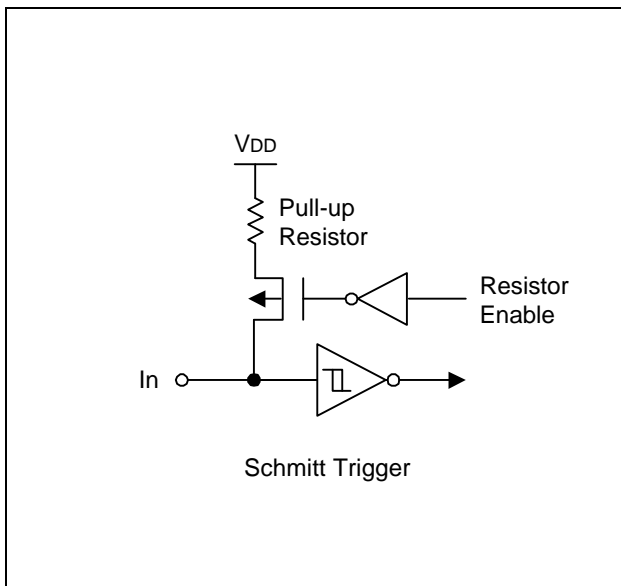


Figure 1-5. Pin Circuit Type A-4 (P1)

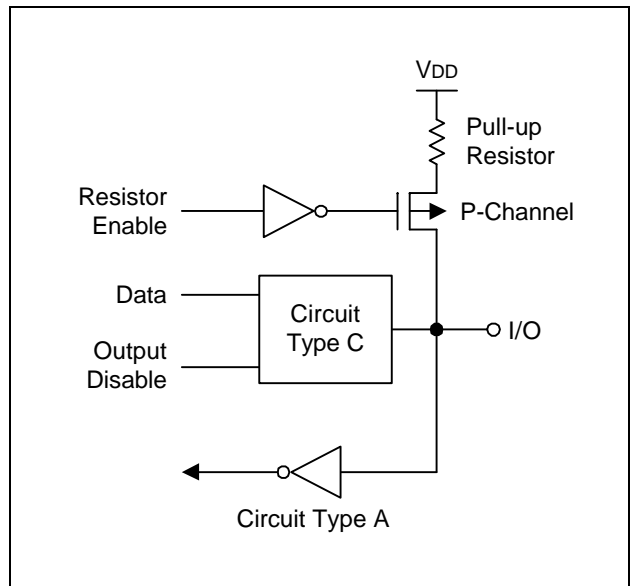


Figure 1-7. Pin Circuit Type D (P2, P3, and P6)

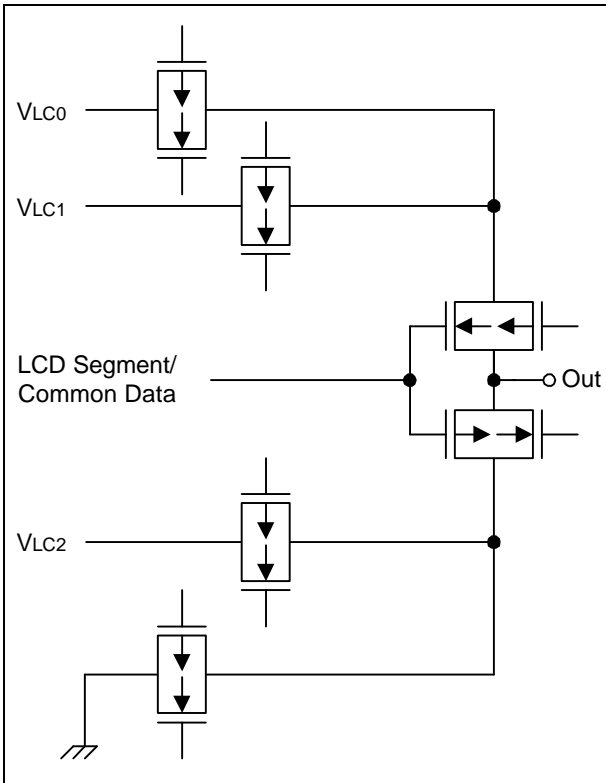


Figure 1-8. Pin Circuit Type H (SEG/COM)

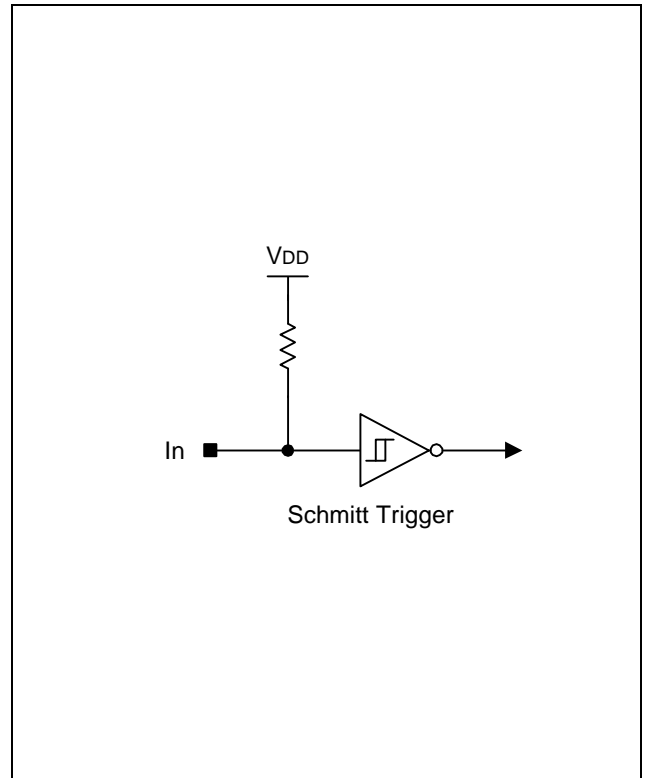


Figure 1-10. Pin Circuit Type B (RESET)

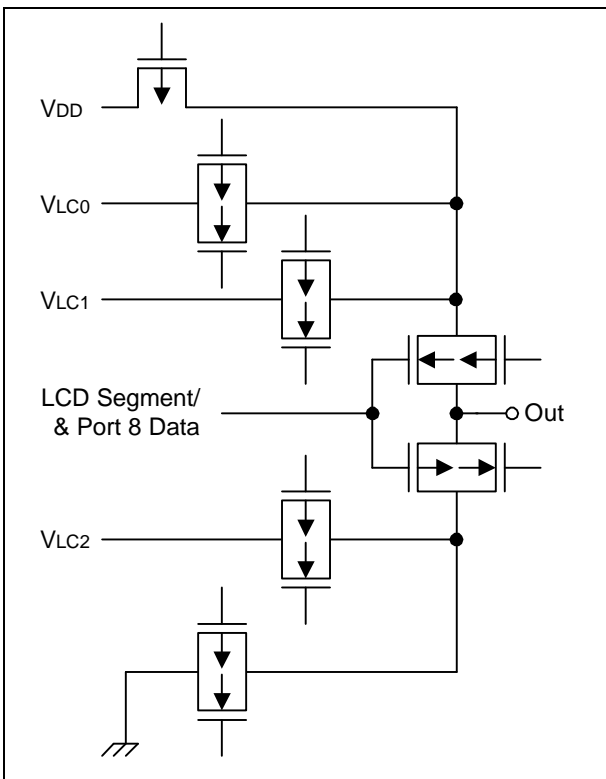


Figure 1-9. Pin Circuit Type H-1 (P8)

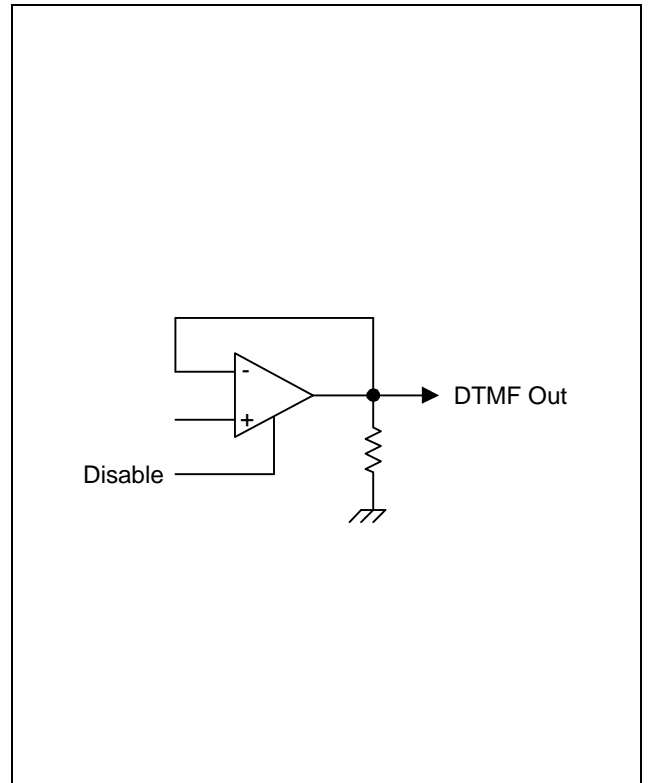


Figure 1-11. Pin Circuit Type G-6 (DTMF)

14 ELECTRICAL DATA

OVERVIEW

In this section, information on S3C7574 electrical characteristics is presented as tables and graphics. The information is arranged in the following order:

Standard Electrical Characteristics

- Absolute maximum ratings
- D.C. electrical characteristics
- Main system clock oscillator characteristics
- Subsystem clock oscillator characteristics
- I/O capacitance
- A.C. electrical characteristics
- Operating voltage range

Miscellaneous Timing Waveforms

- A.C timing measurement point
- Clock timing measurement at X_{IN}
- Clock timing measurement at XT_{IN}
- TCL0 timing
- Input timing for RESET
- Input timing for external interrupts

Stop Mode Characteristics and Timing Waveforms

- RAM data retention supply voltage in stop mode
- Stop mode release timing when initiated by RESET
- Stop mode release timing when initiated by an interrupt request

Table 14-1. Absolute Maximum Ratings

 $(T_A = 25\text{ }^\circ\text{C})$

Parameter	Symbol	Conditions	Rating	Units
Supply Voltage	V_{DD}	–	– 0.3 to + 6.5	V
Input Voltage	V_{I1}	All I/O ports	– 0.3 to $V_{DD} + 0.3$	
Output Voltage	V_O		– 0.3 to $V_{DD} + 0.3$	
Output Current High	I_{OH}	One I/O port active	– 15	mA
		All I/O ports active	– 30	
Output Current Low	I_{OL}	One I/O port active	+ 30 (Peak value)	
			+ 15 (note)	
		Total value for ports 2 and 3	+ 60 (Peak value)	
			+ 20 (note)	
Total value for port 6	+ 50			
	+ 20 (note)			
Operating Temperature	T_A	–	– 40 to + 85	$^\circ\text{C}$
Storage Temperature	T_{stg}	–	– 65 to + 150	

NOTE: The values for Output Current Low (I_{OL}) are calculated as Peak Value $\times \sqrt{\text{Duty}}$.

Table 14-2. D.C. Electrical Characteristics

 $(T_A = -40\text{ }^\circ\text{C}$ to $+85\text{ }^\circ\text{C}$, $V_{DD} = 1.8\text{ V}$ to 5.5 V)

Parameter	Symbol	Conditions	Min	Typ	Max	Units
Input high voltage	V_{IH1}	All input pins except those specified below for V_{IH2} , V_{IH3}	$0.7 V_{DD}$	–	V_{DD}	V
	V_{IH2}	Ports 1, 6, and RESET	$0.8 V_{DD}$	–	V_{DD}	
	V_{IH3}	X_{IN} , X_{OUT} , and XT_{IN}	$V_{DD} - 0.1$	–	V_{DD}	
Input low voltage	V_{IL1}	Ports 2 and 3	–	–	$0.3 V_{DD}$	V
	V_{IL2}	Ports 1, 6 and RESET	–	–	$0.2 V_{DD}$	
	V_{IL3}	X_{IN} , X_{OUT} , and XT_{IN}	–	–	0.1	
Output high voltage	V_{OH1}	$V_{DD} = 4.5\text{ V}$ to 5.5 V $I_{OH} = -1\text{ mA}$ Ports 2, 3, 6 and BIAS	$V_{DD} - 1.0$	–	–	V
	V_{OH2}	$V_{DD} = 4.5\text{ V}$ to 5.5 V $I_{OH} = -100\text{ }\mu\text{A}$ Port 8 only	$V_{DD} - 2.0$	–	–	

Table 14-2. D.C. Electrical Characteristics (Continued)

 $(T_A = -40\text{ }^\circ\text{C to } +85\text{ }^\circ\text{C}, V_{DD} = 1.8\text{ V to } 5.5\text{ V})$

Parameter	Symbol	Conditions	Min	Typ	Max	Units
Output low voltage	V_{OL1}	$V_{DD} = 4.5\text{ V to } 5.5\text{ V}$ $I_{OL} = 15\text{ mA}$, Ports 2, 3, 6	–	0.4	2	V
	V_{OL2}	$V_{DD} = 4.5\text{ V to } 5.5\text{ V}$ $I_{OL} = 100\text{ }\mu\text{A}$; Port 8 only	–	–	1	
Input high leakage current	I_{LIH1}	$V_{IN} = V_{DD}$ All input pins except those specified below for I_{LIH2}	–	–	3	μA
	I_{LIH2}	$V_{IN} = V_{DD}$ X_{IN} , X_{OUT} and XT_{IN}	–	–	20	
Input low leakage current	I_{LIL1}	$V_{IN} = 0\text{ V}$ All input pins except X_{IN} , X_{OUT} , and XT_{IN}	–	–	–3	
	I_{LIL2}	$V_{IN} = 0\text{ V}$ X_{IN} , X_{OUT} , and XT_{IN}	–	–	–20	
Output high leakage current	I_{LOH1}	$V_{OUT} = V_{DD}$ All output pins	–	–	3	μA
Output low leakage current	I_{LOL}	$V_{OUT} = 0\text{ V}$ All output pins	–	–	–3	
Pull-up resistor	R_{L1}	$V_{IN} = 0\text{ V}$; $V_{DD} = 5\text{ V}$ Ports 1, 2, 3, 6	25	50	100	$\text{K}\Omega$
		$V_{DD} = 3\text{ V}$	50	100	200	
	R_{L2}	$V_{IN} = 0\text{ V}$; $V_{DD} = 5\text{ V}$ RESET	100	250	400	
		$V_{DD} = 3\text{ V}$	200	500	800	
LCD voltage dividing resistor	R_{LCD}	$T_A = 25\text{ }^\circ\text{C}$	100	150	200	
COM output impedance	R_{COM}	$V_{DD} = 5\text{ V}$	–	3	6	
		$V_{DD} = 3\text{ V}$	–	5	15	
SEG output impedance	R_{SEG}	$V_{DD} = 5\text{ V}$	–	3	6	
		$V_{DD} = 3\text{ V}$	–	5	15	
COM output voltage deviation	V_{DC}	$V_{DD} = 5\text{ V}$ ($V_{LC0-COM_i}$) $I_O = \pm\text{ }\mu\text{A}$ ($I = 0-3$)	–	± 45	± 90	mV

Table 14-2. D.C. Electrical Characteristics (Continued)

(T_A = -40 °C to +85 °C, V_{DD} = 1.8 V to 5.5 V)

Parameter	Symbol	Conditions	Min	Typ	Max	Units
SEG output voltage deviation	V _{DS}	V _{DD} = 5 V (V _{LC0} -EG _i) I _O = ± 15 μA (i = 031)	-	± 45	± 90	mV
V _{LC0} Output voltage	V _{LC0}	T _A = 25 °C	0.6 V _{DD} - 0.2	0.6 V _{DD}	0.6 V _{DD} + 0.2	V
V _{LC1} Output voltage	V _{LC1}	T _A = 25 °C	0.4 V _{DD} - 0.2	0.4 V _{DD}	0.4 V _{DD} + 0.2	
V _{LC2} Output voltage	V _{LC2}	T _A = 25 °C	0.2 V _{DD} - 0.2	0.2 V _{DD}	0.2 V _{DD} + 0.2	

Table 14-2. D.C. Electrical Characteristics (Continued)

 $(T_A = -40\text{ }^\circ\text{C to } +85\text{ }^\circ\text{C}, V_{DD} = 1.8\text{ V to } 5.5\text{ V})$

Parameter	Symbol	Conditions	Min	Typ	Max	Units		
Supply Current (1)	$I_{DD1}^{(2)}$ (DTMF On)	Main operating: $V_{DD} = 5\text{ V} \pm 10\%$ CPU = $f_x/4$ SCMOD = 0000B Crystal oscillator C1 = C2 = 22 pF	3.58 MHz	–	3.9	7.0	mA	
		$V_{DD} = 3\text{ V} \pm 10\%$			2.0	4.0		
	$I_{DD2}^{(2)}$ (DTMF Off)	Main idle mode; $V_{DD} = 5\text{ V} \pm 10\%$ CPU = $f_x/4$ SCMOD = 0000B Crystal oscillator C1 = C2 = 22 pF	6.0 MHz 3.58 MHz	–	3.5 2.5	8.0 5.0		
		$V_{DD} = 3\text{ V} \pm 10\%$	6.0 MHz 3.58 MHz		1.6 1.2	4.0 2.3		
	$I_{DD3}^{(2)}$	Main operating: $V_{DD} = 5\text{ V} \pm 10\%$ CPU = $f_x/4$, SCMOD = 0000B Crystal oscillator C1 = C2 = 22 pF	6.0 MHz 3.58 MHz	–	1.0 0.9	2.5 1.8		
		$V_{DD} = 3\text{ V} \pm 10\%$	6.0 MHz 3.58 MHz		0.5 0.4	1.0 0.8		
	I_{DD4}	Sub operating: $V_{DD} = 3\text{ V} \pm 10\%$ CPU = $f_{xt}/4$, SCMOD = 1001B 32 kHz crystal oscillator		–	15	30		μA
	I_{DD5}	Sub idle mode: $V_{DD} = 3\text{ V} \pm 10\%$ CPU = $f_{xt}/4$, SCMOD = 1001B 32 kHz crystal oscillator		–	6	15		
I_{DD6}	Stop mode; $V_{DD} = 5\text{ V} \pm 10\%$ $V_{DD} = 3\text{ V} \pm 10\%$	SCMOD = 0000B $X_{T_{IN}} = 0\text{ V}$	–	2.0 0.6	5 3			
	Stop mode; $V_{DD} = 5\text{ V} \pm 10\%$ $V_{DD} = 3\text{ V} \pm 10\%$	SCMOD = 0100B		0.2 0.1	3 2			

Table 14-2. D.C. Electrical Characteristics (Continued)

(T_A = -40 °C to +85 °C, V_{DD} = 1.8 V to 5.5 V)

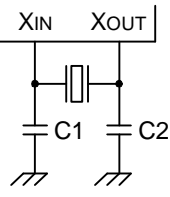
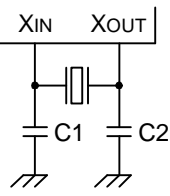
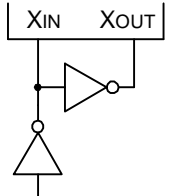
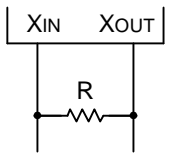
Parameter	Symbol	Conditions	Min	Typ	Max	Units
Row Tone Level	V _{ROW}	V _{DD} = 2.0 to 5.5 V R _L = 12 kΩ; Temp = -30 to 60 °C	-16.0	-14.0	-12.0	dBV
Ratio of Column to Row tone	dB _{CR}	V _{DD} = 2.0 to 5.5 V R _L = 12 kΩ; Temp = -30 to 60 °C	1	2	3	dB
Distortion (Dual tone)	THD	V _{DD} = 2.0 to 5.5 V 1 MHz band R _L = 12 kΩ; Temp = -30 to 60 °C	-	-	5	%

NOTES:

1. D.C. electrical values for supply current (I_{DD1} to I_{DD7}) do not include current drawn through internal pull-up resistors and through LCD voltage dividing resistors.
2. Data includes the power consumption for sub-system clock oscillation.
3. When the system clock mode register, SCMOD, is set to 0100B, the sub-system clock oscillation stops. The main-system clock oscillation stops by the STOP instruction.

Table 14-3. Main System Clock Oscillator Characteristics

 $(T_A = -40\text{ }^{\circ}\text{C} + 85\text{ }^{\circ}\text{C}, V_{DD} = 1.8\text{ V to } 5.5\text{ V})$

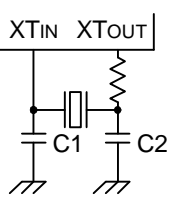
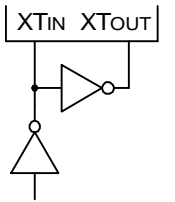
Oscillator	Clock Configuration	Parameter	Test Condition	Min	Typ	Max	Units
Ceramic Oscillator		Oscillation frequency (1)	–	0.4	–	6.0	MHz
		Stabilization time (2)	Stabilization occurs when V_{DD} is equal to the minimum oscillator voltage range.	–	–	4	ms
Crystal Oscillator		Oscillation frequency (1)	–	0.4	–	6.0	MHz
		Stabilization time (2)	$V_{DD} = 4.5\text{ V to } 5.5\text{ V}$	–	–	10	ms
			$V_{DD} = 1.8\text{ V to } 4.5\text{ V}$	–	–	30	
External Clock		X_{IN} input frequency (1)	–	0.4	–	6.0	MHz
		X_{IN} input high and low level width (t_{XH} , t_{XL})	–	83.3	–	–	ns
RC Oscillator		Frequency (1)	$V_{DD} = 5\text{ V}$ $R = 20\text{ K}\Omega, V_{DD} = 5\text{ V}$ $R = 39\text{ K}\Omega, V_{DD} = 3\text{ V}$	0.4	– 2.0 1.0	2	MHz

NOTES:

- Oscillation frequency and X_{IN} input frequency data are for oscillator characteristics only.
- Stabilization time is the interval required for oscillator stabilization after a power-on occurs, or when stop mode is terminated.

Table 14-4. Subsystem Clock Oscillator Characteristics

($T_A = -40\text{ }^\circ\text{C} + 85\text{ }^\circ\text{C}$, $V_{DD} = 1.8\text{ V to } 5.5\text{ V}$)

Oscillator	Clock Configuration	Parameter	Test Condition	Min	Typ	Max	Units
Crystal Oscillator		Oscillation frequency (1)	–	32	32.768	35	kHz
		Stabilization time (2)	$V_{DD} = 4.5\text{ V to } 5.5\text{ V}$	–	1.0	2	s
			$V_{DD} = 1.8\text{ V to } 4.5\text{ V}$	–	–	10	
External Clock		XT_{IN} input frequency (1)	–	32	–	100	kHz
		XT_{IN} input high and low level width (t_{XTL} , t_{XTH})	–	5	–	15	μs

NOTES:

- Oscillation frequency and XT_{IN} input frequency data are for oscillator characteristics only.
- Stabilization time is the interval required for oscillator stabilization after a power-on occurs.

Table 14-5. Input/output Capacitance

 $(T_A = 25\text{ }^\circ\text{C}, V_{DD} = 0\text{ V})$

Parameter	Symbol	Condition	Min	Typ	Max	Units
Input capacitance	C_{IN}	f = 1 MHz; Unmeasured pins are returned to V_{SS}	–	–	15	pF
Output capacitance	C_{OUT}		–	–	15	pF
I/O capacitance	C_{IO}		–	–	15	pF

Table 14-6. A.C. Electrical Characteristics

 $(T_A = -40\text{ }^\circ\text{C to } +85\text{ }^\circ\text{C}, V_{DD} = 1.8\text{ V to } 5.5\text{ V})$

Parameter	Symbol	Conditions	Min	Typ	Max	Units
Instruction cycle time (1)	t_{CY}	$V_{DD} = 2.7\text{ V to } 5.5\text{ V}$	0.67	–	64	μs
		$V_{DD} = 1.8\text{ V to } 5.5\text{ V}$	0.95	–	64	
		With subsystem clock (fxt)	114	122	125	
TCL0 input frequency	f_{TIO}	$V_{DD} = 2.7\text{ V to } 5.5\text{ V}$	0	–	1.5	MHz
		$V_{DD} = 1.8\text{ V to } 5.5\text{ V}$			1	MHz
TCL0 input high, low width	t_{TIHO}, t_{TILO}	$V_{DD} = 2.7\text{ V to } 5.5\text{ V}$	0.48	–	–	μs
		$V_{DD} = 1.8\text{ V to } 5.5\text{ V}$	1.8			
Interrupt input high, low width	t_{INTH}, t_{INTL}	INT0	(2)	–	–	μs
		INT1, INT2, KS0–KS3	10			
RESET Input Low Width	t_{RSL}	Input	10	–	–	μs

NOTES:

- Unless otherwise specified, Instruction Cycle Time condition values assume a main system clock (fx) source.
- Minimum value for INT0 is based on a clock of $2t_{CY}$ or $128/\text{fx}$ as assigned by the IMOD0 register setting.

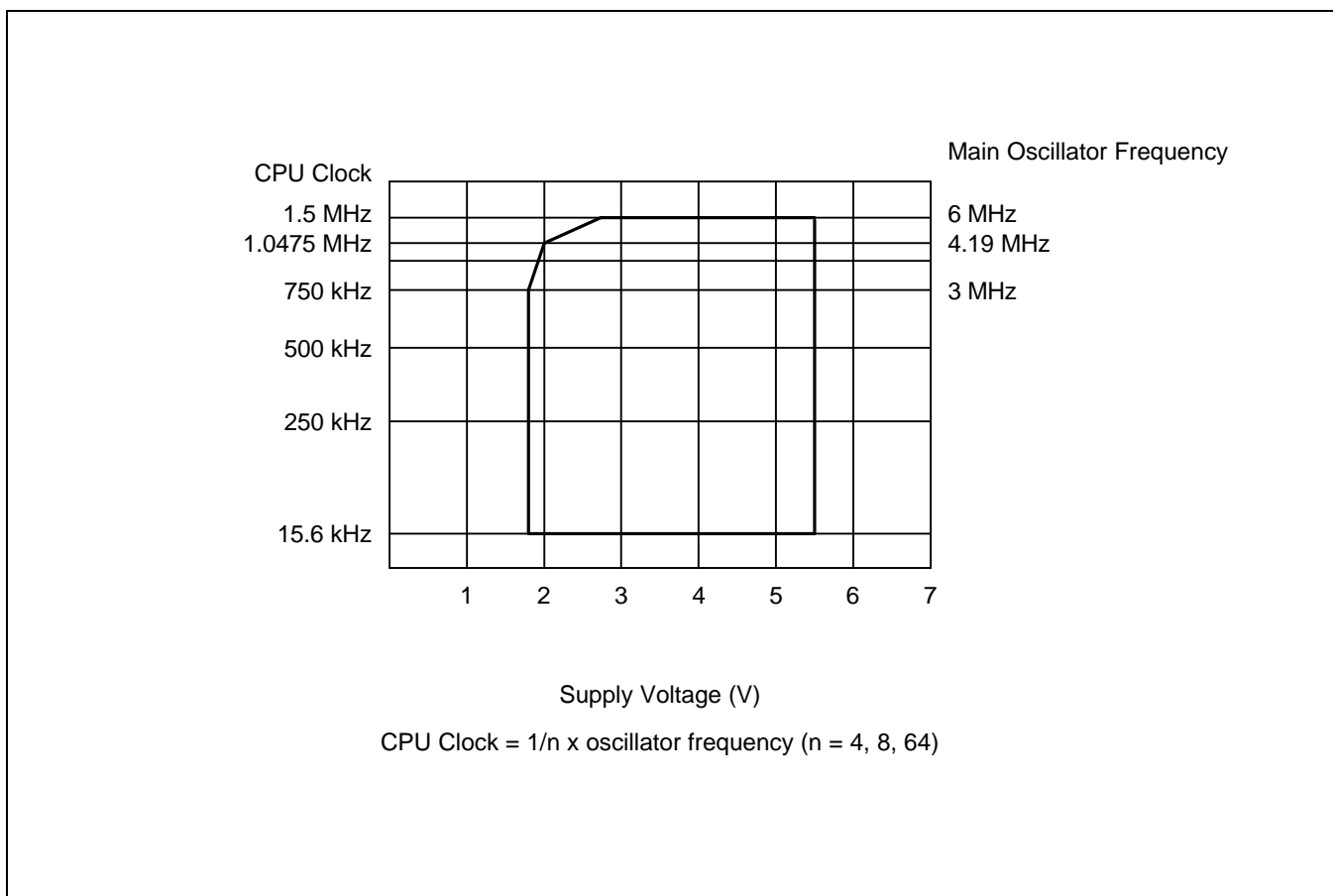


Figure 14-1. Standard Operating Voltage Range

Table 14-7. RAM Data Retention Supply Voltage in Stop Mode

($T_A = -40\text{ }^{\circ}\text{C}$ to $+85\text{ }^{\circ}\text{C}$)

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Data retention supply voltage	V_{DDDR}	Normal operation	1.5	–	6.5	V
Data retention supply current	I_{DDDR}	$V_{\text{DDDR}} = 2.0\text{ V}$	–	0.1	1	μA
Release signal set time	t_{SREL}	Normal operation	0	–	–	μs
Oscillator stabilization wait time (1)	t_{WAIT}	Released by RESET	–	$2^{17}/f_x$	–	ms
		Released by interrupt	–	(2)	–	

NOTES:

1. During oscillator stabilization wait time, all CPU operations must be stopped to avoid instability during oscillator start-up.
2. Use the basic timer mode register (BMOD) interval timer to delay execution of CPU instructions during the wait time.

TIMING WAVEFORMS

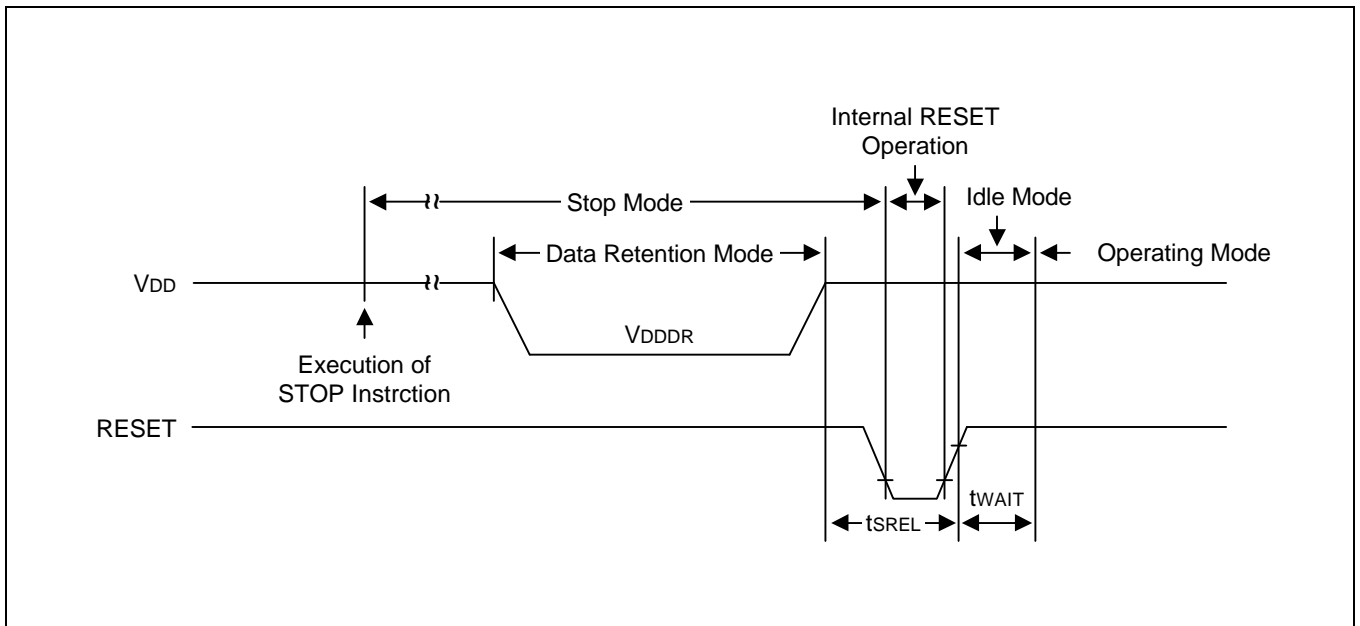


Figure 14-2. Stop Mode Release Timing When Initiated by RESET

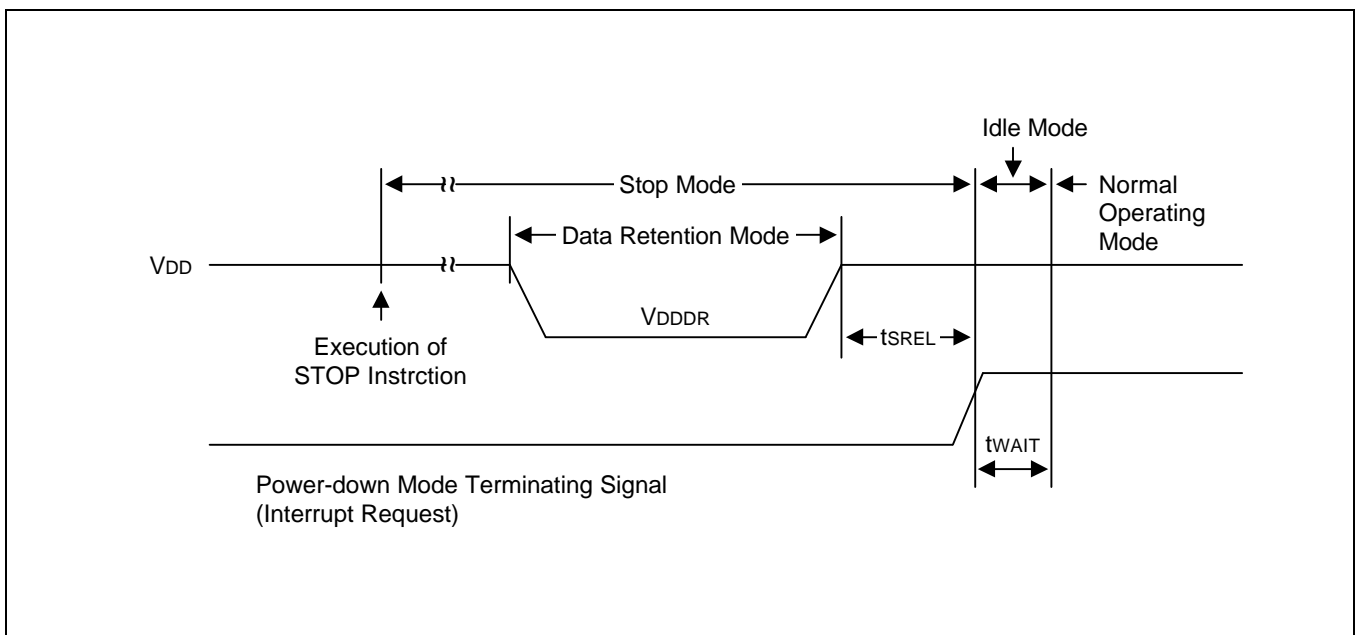
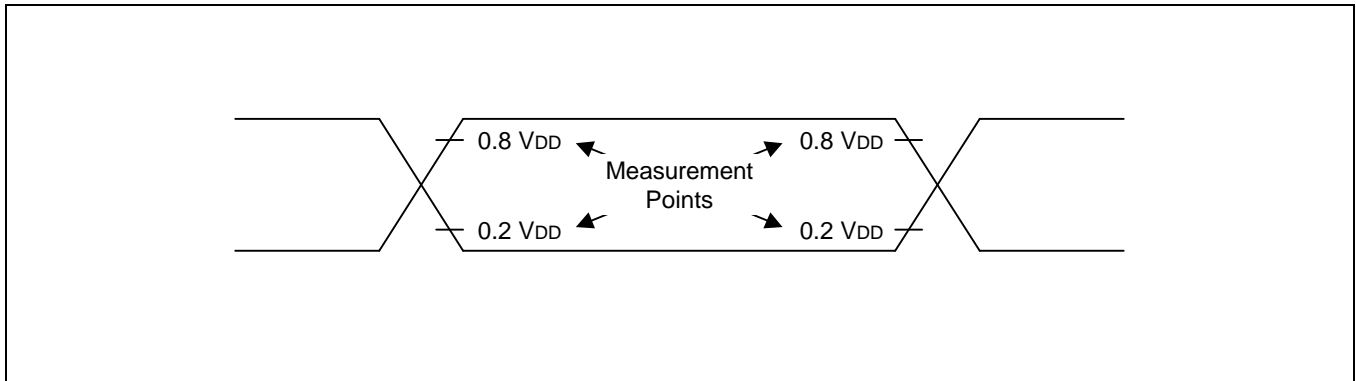
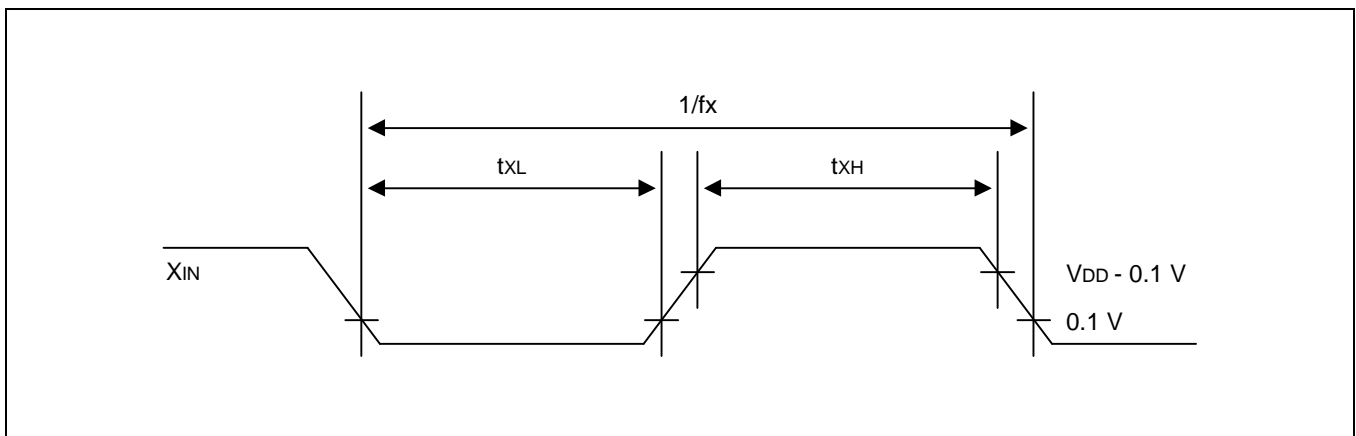
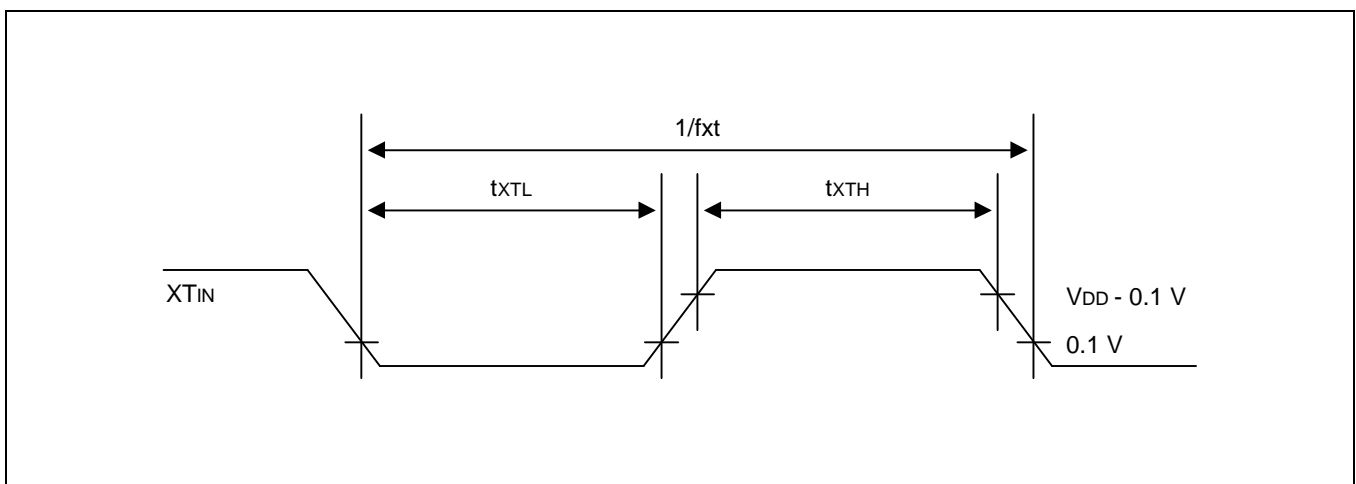


Figure 14-3. Stop Mode Release Timing When Initiated by Interrupt Request

Figure 14-4. A.C. Timing Measurement Points (Except for X_{IN} and XT_{IN})Figure 14-5. Clock Timing Measurement at X_{IN} Figure 14-6. Clock Timing Measurement at XT_{IN}

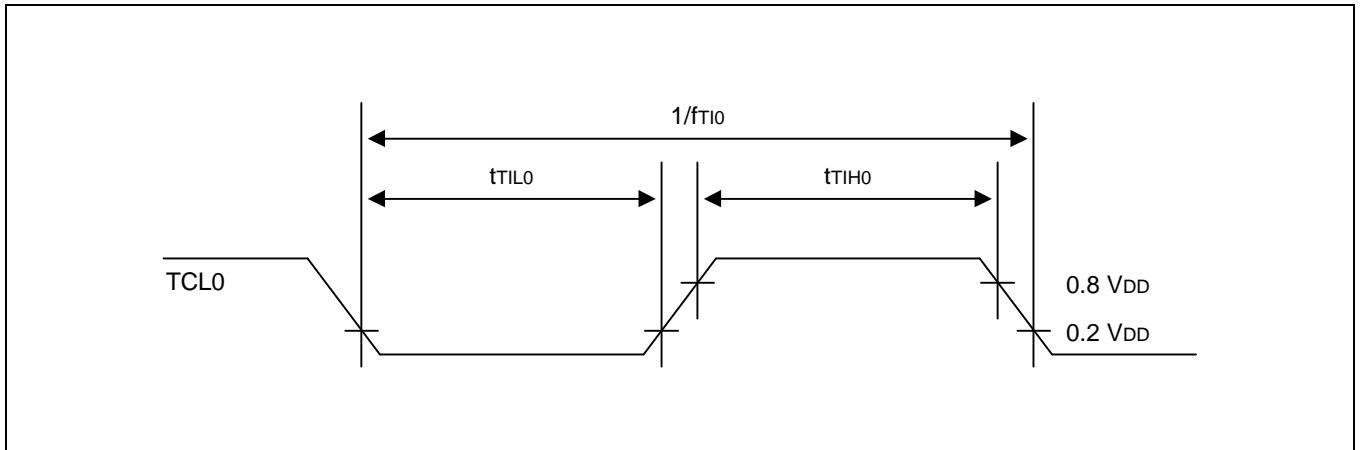


Figure 14-7. TCL0 Timing

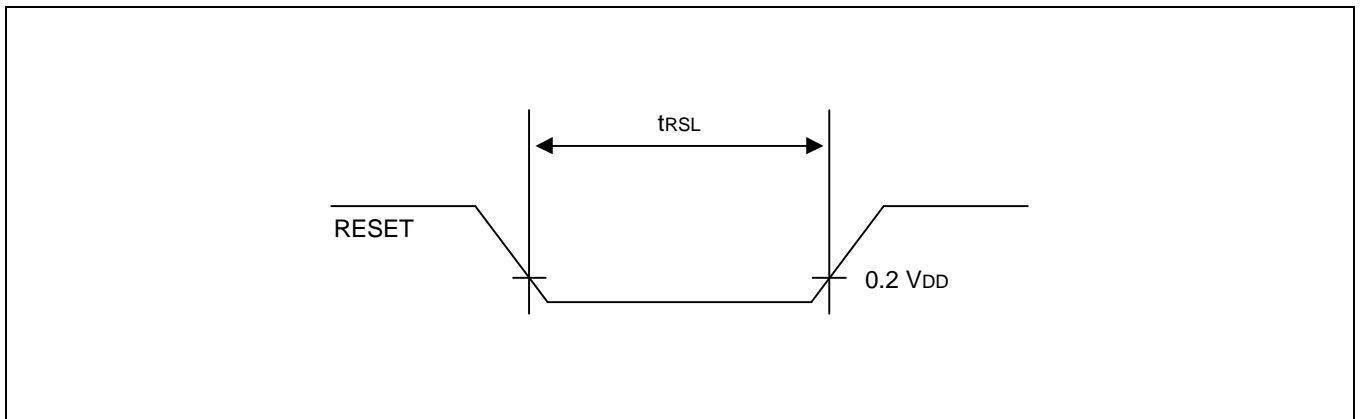


Figure 14-8. Input Timing for RESET Signal

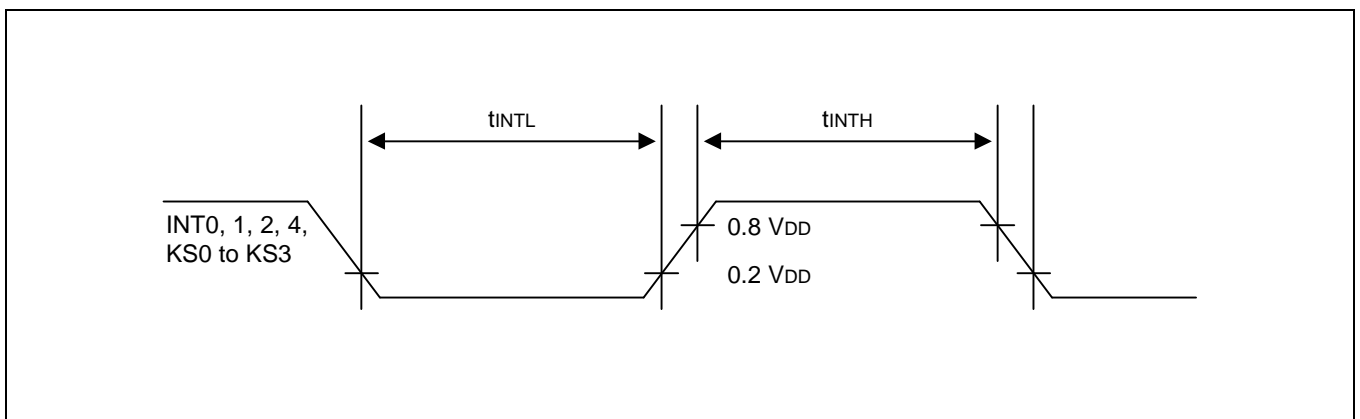


Figure 14-9. Input Timing for External Interrupts and Quasi-Interrupts

15 MECHANICAL DATA

OVERVIEW

The S3C7574 microcontroller is available in a 64-pin QFP package (Samsung: 64-QFP-1420F and 64-QFP-1414). Package dimensions are shown in Figure 15-1 and Figure 15-2.

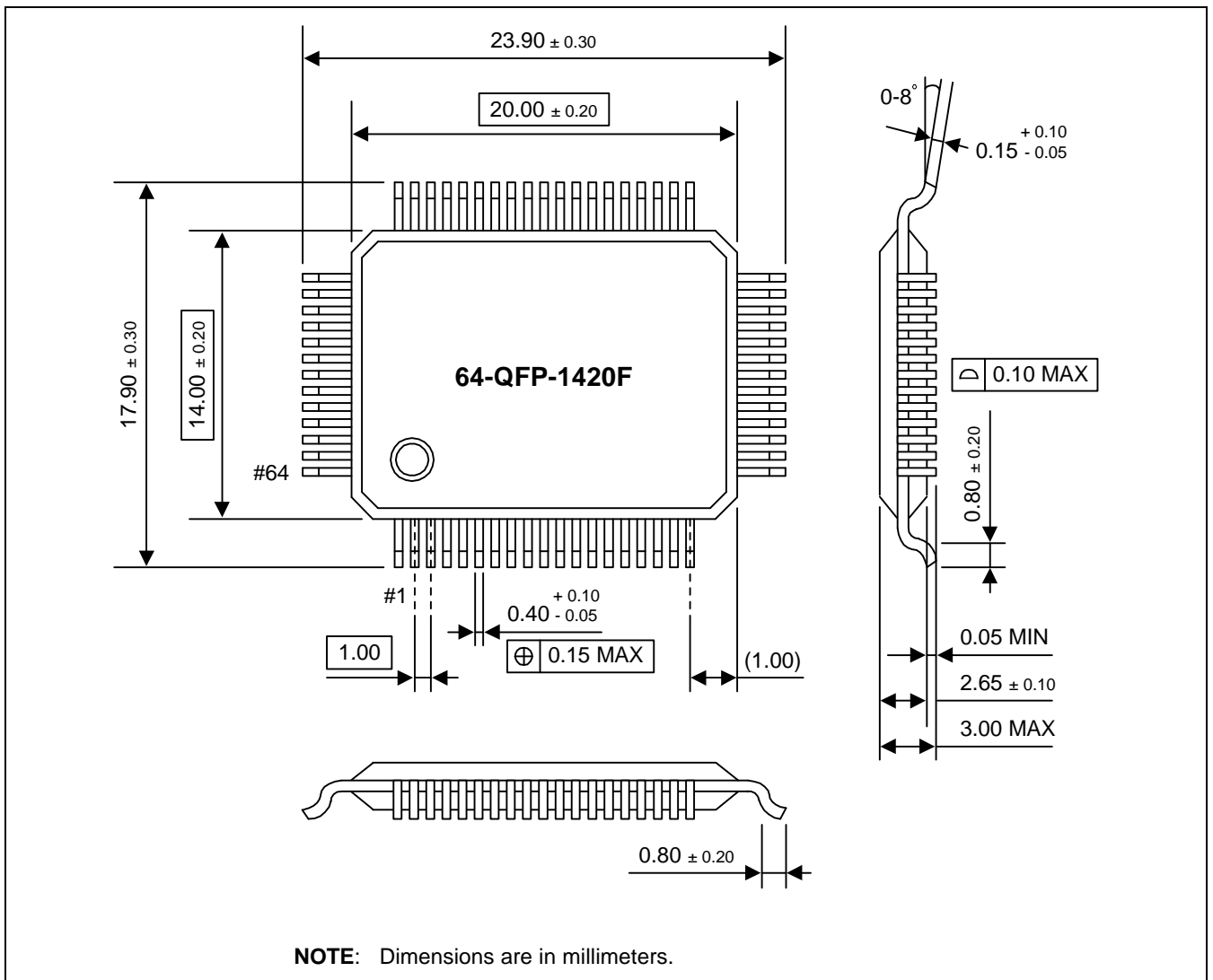


Figure 15-1. 64-QFP-1420F Package Dimensions

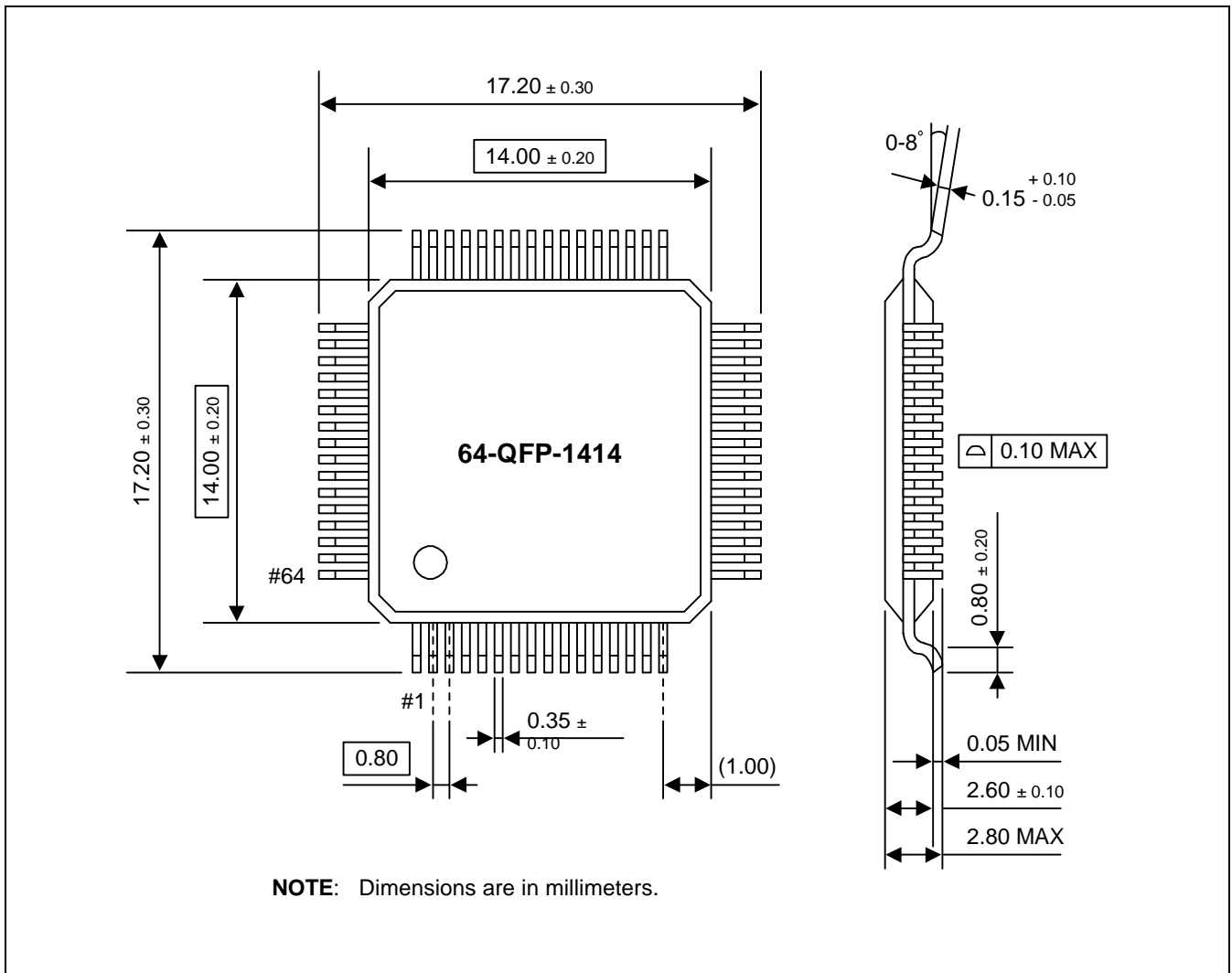


Figure 15-2. 64-QFP-1414 Package Dimensions.

16

S3P7574 OTP

OVERVIEW

The S3P7574 single-chip CMOS microcontroller is the OTP (One Time Programmable) version of the S3C7574 microcontroller. It has an on-chip EPROM instead of masked ROM. The EPROM is accessed by a serial data format.

The S3P7574 is fully compatible with the S3C7574, both in function and in pin configuration. Because of its simple programming requirements, the S3P7574 is ideal for use as an evaluation chip for the S3C7574.

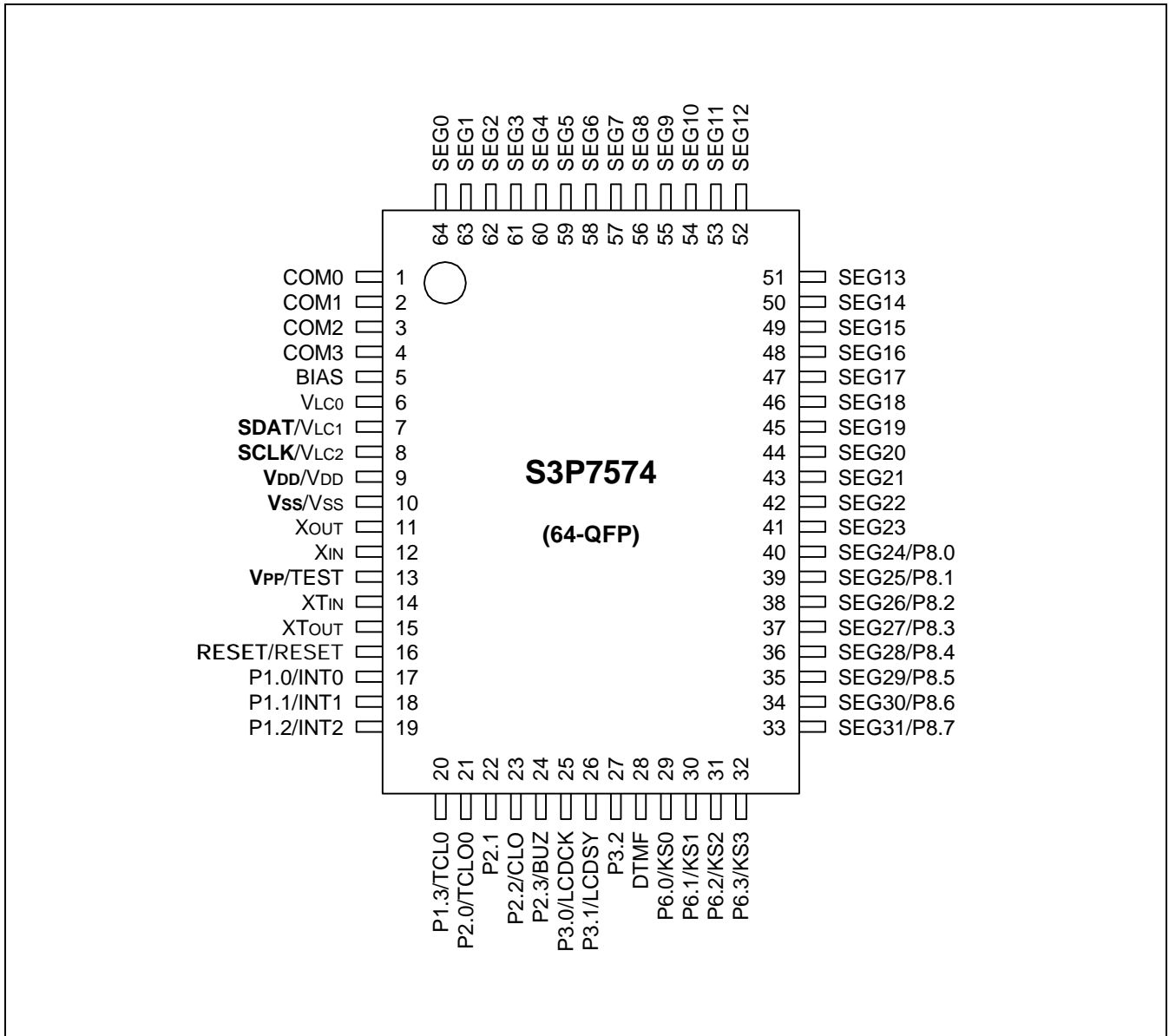


Figure 16-1. S3P7574 Pin Assignments (64-QFP)

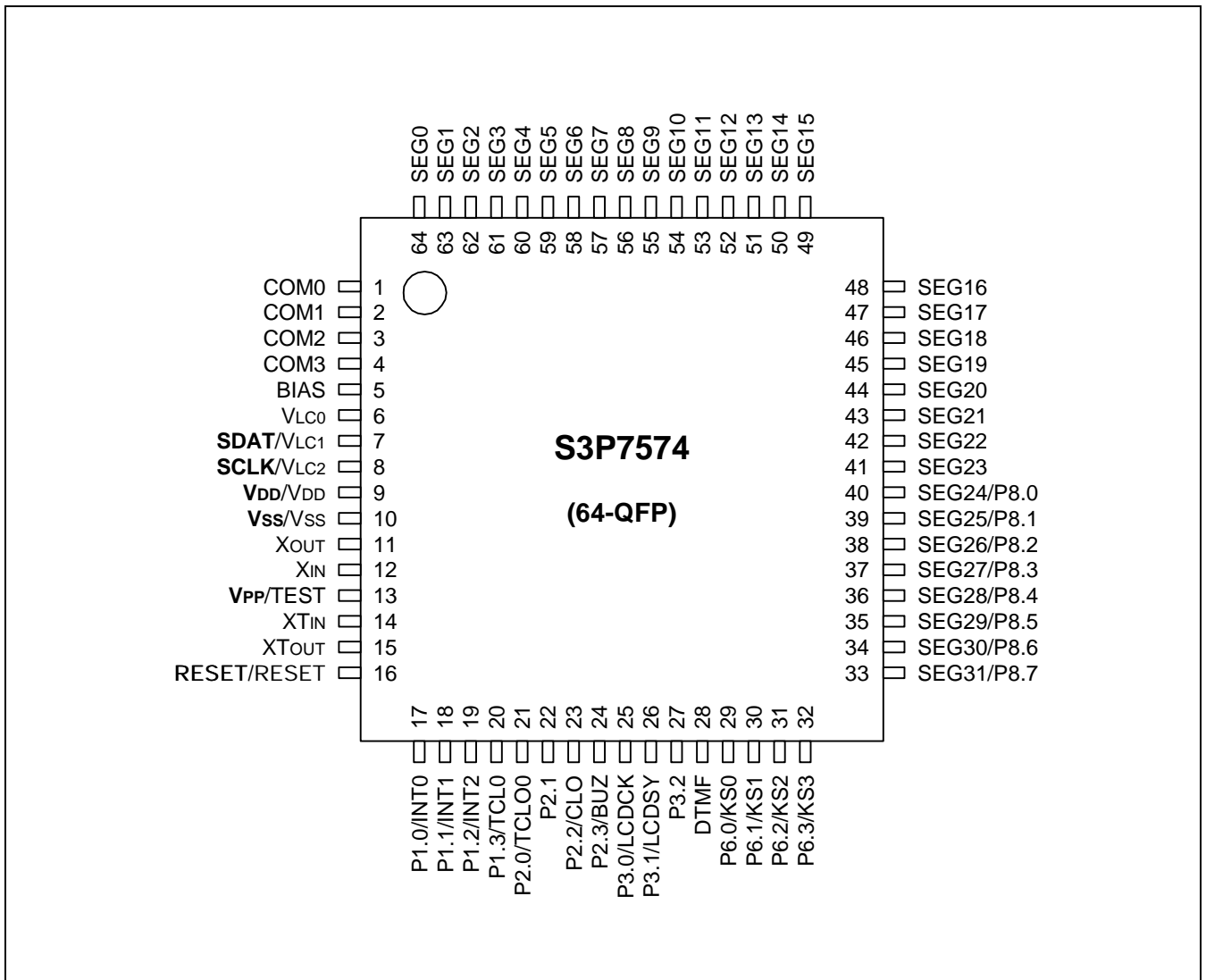


Figure 16-2. S3P7574 Pin Assignments (64-QFP)

Table 16-1. Pin Descriptions Used to Read/Write the EPROM

Main Chip	During Programming			
Pin Name	Pin Name	Pin No.	I/O	Function
V _{LC1}	SDAT	7	I/O	Serial data pin. Output port when reading and input port when writing. Can be assigned as a Input/push-pull output port.
V _{LC2}	SCLK	8	I/O	Serial clock pin. Input only pin.
TEST	V _{PP} (TEST)	13	I	Power supply pin for EPROM cell writing (indicates that OTP enters into the writing mode). When 12.5 V is applied, OTP is in writing mode and when 5 V is applied, OTP is in reading mode. (Option)
RESET	RESET	16	I	Chip initialization
V _{DD} /V _{SS}	V _{DD} /V _{SS}	9/10	I	Logic power supply pin. V _{DD} should be tied to + 5 V during programming.

Table 16-2. Comparison of S3P7574 and S3C7574 Features

Characteristic	S3P7574	S3C7574
Program Memory	4-Kbyte EPROM	4-Kbyte mask ROM
Operating Voltage (V _{DD})	2.0 V to 5.5 V at 4.19 MHz 1.8 V to 5.5 V at 3 MHz	2.0 V to 5.5 V at 4.19 MHz 1.8 V to 5.5 V at 3 MHz
OTP Programming Mode	V _{DD} = 5 V, V _{PP} (TEST) = 12.5 V	–
Pin Configuration	64 QFP	64 QFP
EPROM Programmability	User Program 1 time	Programmed at the factory

OPERATING MODE CHARACTERISTICS

When 12.5 V is supplied to the V_{PP} (TEST) pin of the S3P7574, the EPROM programming mode is entered. The operating mode (read, write, or read protection) is selected according to the input signals to the pins listed in Table 16-3 below.

Table 16-3. Operating Mode Selection Criteria

V _{DD}	V _{pp} (TEST)	REG/MEM	Address (A15–A0)	R/W	Mode
5 V	5 V	0	0000H	1	EPROM read
	12.5 V	0	0000H	0	EPROM program
	12.5 V	0	0000H	1	EPROM verify
	12.5 V	1	0E3FH	0	EPROM read protection

NOTE: "0" means low level; "1" means high level.

Table 16-4. D.C. Electrical Characteristics

(T_A = -40 °C to +85 °C, V_{DD} = 1.8 V to 5.5 V)

Parameter	Symbol	Conditions	Min	Typ	Max	Units
Input high voltage	V _{IH1}	All input pins except those specified below for V _{IH2} , V _{IH3}	0.7 V _{DD}	–	V _{DD}	V
	V _{IH2}	Ports 1, 6, and RESET	0.8 V _{DD}	–	V _{DD}	
	V _{IH3}	X _{IN} , X _{OUT} , and XT _{IN}	V _{DD} -0.1	–	V _{DD}	
Input low voltage	V _{IL1}	Ports 2 and 3	–	–	0.3 V _{DD}	V
	V _{IL2}	Ports 1, 6 and RESET	–	–	0.2 V _{DD}	
	V _{IL3}	X _{IN} , X _{OUT} , and XT _{IN}	–	–	0.1	
Output high voltage	V _{OH1}	V _{DD} = 4.5 V to 5.5 V I _{OH} = -1 mA Ports 2, 3, 6 and BIAS	V _{DD} -1.0	–	–	V
	V _{OH2}	V _{DD} = 4.5 V to 5.5 V I _{OH} = -100 μA Port 8 only	V _{DD} -2.0	–	–	
Output low voltage	V _{OL1}	V _{DD} = 4.5 V to 5.5 V I _{OL} = 15 mA, Ports 2, 3, 6	–	0.4	2	V
	V _{OL2}	V _{DD} = 4.5 V to 5.5 V I _{OL} = 100 μA; Port 8 only	–	–	1	
Input high leakage current	I _{LIH1}	V _{IN} = V _{DD} All input pins except those specified below for I _{LIH2}	–	–	3	μA
	I _{LIH2}	V _{IN} = V _{DD} X _{IN} , X _{OUT} and XT _{IN}	–	–	20	
Input low leakage current	I _{LIL1}	V _{IN} = 0 V All input pins except X _{IN} , X _{OUT} , and XT _{IN}	–	–	-3	μA
	I _{LIL2}	V _{IN} = 0 V X _{IN} , X _{OUT} , and XT _{IN}	–	–	-20	
Output high leakage current	I _{LOH1}	V _{OUT} = V _{DD} All output pins	–	–	3	μA
Output low leakage current	I _{LOL}	V _{OUT} = 0 V All output pins	–	–	-3	

Table 16-4. D.C. Electrical Characteristics (Continued)

(T_A = -40 °C to +85 °C, V_{DD} = 1.8 V to 5.5 V)

Parameter	Symbol	Conditions	Min	Typ	Max	Units	
Pull-up resistor	R _{L1}	V _{IN} = 0 V; V _{DD} = 5 V Ports 1, 2, 3, 6	25	50	100	KΩ	
		V _{DD} = 3 V	50	100	200		
	R _{L2}	V _{IN} = 0 V; V _{DD} = 5 V RESET	100	250	400		
		V _{DD} = 3 V	200	500	800		
LCD voltage dividing resistor	R _{LCD}	T _A = 25 °C	100	150	200		
COM output impedance	R _{COM}	V _{DD} = 5 V	-	3	6		
		V _{DD} = 3 V		5	15		
SEG output impedance	R _{SEG}	V _{DD} = 5 V		3	6		
		V _{DD} = 3 V		5	15		
COM output voltage deviation	V _{DC}	V _{DD} = 5 V (V _{LC0} -COM _i) I _O = ± 15 μA (I = 0-3)		-	± 45	± 90	mV
SEG output voltage deviation	V _{DS}	V _{DD} = 5 V (V _{LC0} -SEG _i) I _O = ± 15 μA (I = 0-31)		-	± 45	± 90	mV
V _{LC0} Output voltage	V _{LC0}	T _A = 25 °C	0.6 V _{DD} - 0.2	0.6 V _{DD}	0.6 V _{DD} + 0.2	V	
V _{LC1} Output voltage	V _{LC1}	T _A = 25 °C	0.4 V _{DD} - 0.2	0.4 V _{DD}	0.4 V _{DD} + 0.2		
V _{LC2} Output voltage	V _{LC2}	T _A = 25 °C	0.2 V _{DD} - 0.2	0.2 V _{DD}	0.2 V _{DD} + 0.2		

Table 16-4. D.C. Electrical Characteristics (Continued)

(T_A = -40 °C to +85 °C, V_{DD} = 1.8 V to 5.5 V)

Parameter	Symbol	Conditions	Min	Typ	Max	Units	
Supply Current (1)	I _{DD1} ⁽²⁾	Main operating: V _{DD} = 5 V ± 10 % CPU = fx/4 SCMOD = 0000B Crystal oscillator C1 = C2 = 22 pF	6.0 MHz 4.19 MHz	-	3.5 2.5	8 5.5	mA
		V _{DD} = 3 V ± 10 %	6.0 MHz 4.19 MHz		1.6 1.2	4 3	
	I _{DD2} ⁽²⁾	Main idle mode; V _{DD} = 5 V ± 10 % CPU = fx/4 SCMOD = 0000B Crystal oscillator C1 = C2 = 22 pF	6.0 MHz 4.19 MHz	-	1 0.9	2.5 2	
		V _{DD} = 3 V ± 10 %	6.0 MHz 4.19 MHz		0.5 0.4	1.0 0.8	
	I _{DD3}	Sub operating: V _{DD} = 3 V ± 10 % CPU = fxt/4, SCMOD = 1001B 32 kHz crystal oscillator		-	15	30	μA
	I _{DD4}	Sub idle mode: V _{DD} = 3 V ± 10 % CPU = fxt/4, SCMOD = 1001B 32 kHz crystal oscillator		-	6	15	
I _{DD5}	Stop mode: V _{DD} = 5 V ± 10 % CPU=fxt/4, SCMOD = 1101B		-	0.5	3		
I _{DD6} ⁽³⁾	Stop mode: V _{DD} = 5 V ± 10 % CPU = fx/4, SCMOD = 0100B						

NOTES:

- D.C. electrical values for supply current (I_{DD1} to I_{DD6}) do not include current drawn through internal pull-up resistors and through LCD voltage dividing resistors.
- Data includes the power consumption for sub-system clock oscillation.
- When the system clock mode register, SCMOD, is set to 0100B, the sub-system clock oscillation stops. The main-system clock oscillation stops by the STOP instruction.

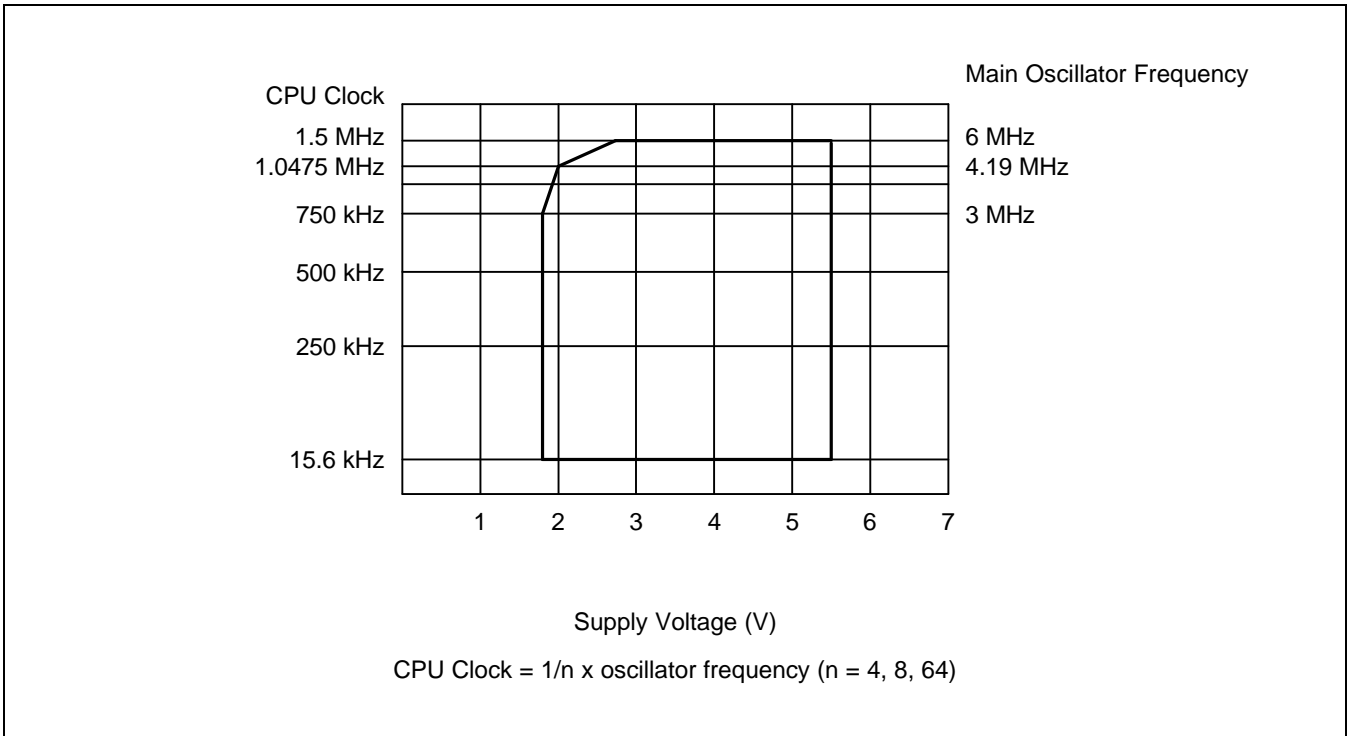


Figure 16-3. Standard Operating Voltage Range

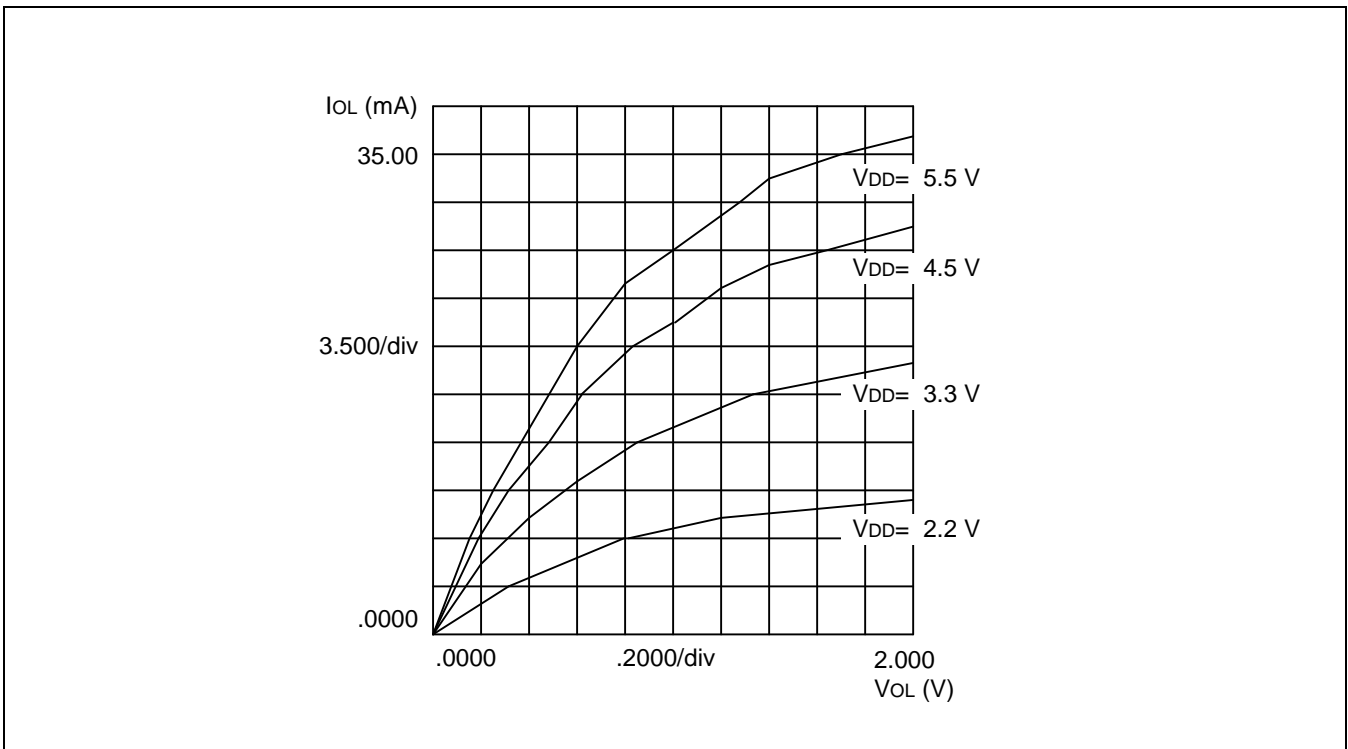


Figure 16-4. Port 2 I_{OL} vs V_{OL} Curve